

ATTENTION OBSERVE PRECAUTIONS FOR HANDLING ELECTROSTATIC DISCHARGE SENSITIVE DEVICES

Features

- 2.8mmX0.8mm right angle SMT LED, 1.2mm thickness.
- Low power consumption.
- Ideal for backlight and indicator.
- Package : 2000pcs / reel.
- Moisture sensitivity level : level 3.
- RoHS compliant.

2.8X0.8mm RIGHT ANGLE SMD CHIP LED LAMP

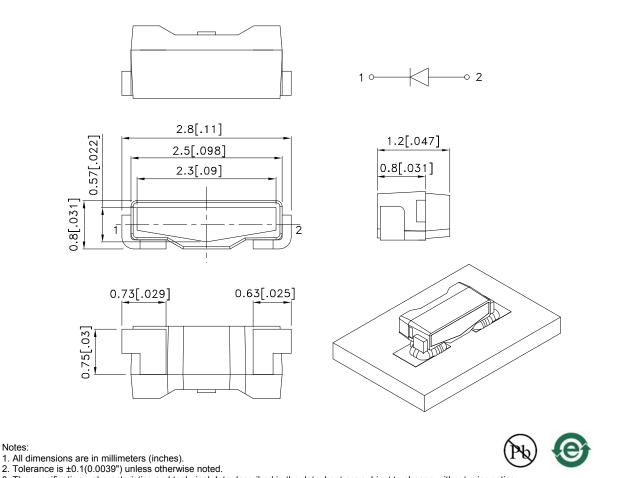
White

Part Number: AA2810AVWD1S

Descriptions

- The source color devices are made with InGaN Light Emitting Diode.
- Electrostatic discharge and power surge could damage the LEDs.
- It is recommended to use a wrist band or antielectrostatic glove when handling the LEDs.
- All devices, equipments and machineries must be electrically grounded.

Package Dimensions



The specifications, characteristics and technical data described in the datasheet are subject to change without prior notice.
The device has a single mounting surface. The device must be mounted according to the specifications.

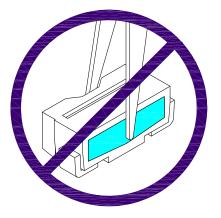
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Handling Precautions

Compare to epoxy encapsulant that is hard and brittle, silicone is softer and flexible. Although its characteristic significantly reduces thermal stress, it is more susceptible to damage by external mechanical force. As a result, special handling precautions need to be observed during assembly using silicone encapsulated LED products. Failure to comply might lead to damage and premature failure of the LED.

1. Do not directly touch or handle the silicone lens surface. It may damage the internal circuitry.



2. As silicone encapsulation is permeable to gases, some corrosive substances such as H_2S might corrode silver plating of leadframe. Special care should be taken if an LED with silicone encapsulation is to be used near such substances.

Selection Guide

Selection Guide								
Part No.	Dice	Lens Type	lv (mcd) [2] @ 20mA		Viewing Angle [1]			
			Min.	Тур.	201/2			
AA2810AVWD1S	White (InGaN)	Water Clear	1300	1700	110°			

Notes:

1. θ 1/2 is the angle from optical centerline where the luminous intensity is 1/2 of the optical peak value.

2. Luminous intensity/ luminous Flux: +/-15%.

3. Luminous intensity value is traceable to the CIE127-2007 compliant national standards.

Electrical / Optical Characteristics at TA=25°C

Symbol	Parameter	Device Typ.		Max.	Units	Test Conditions
VF [1]	Forward Voltage	White	3.3	4.0	V	l⊧=20mA
lr	Reverse Current	White		50	uA	VR = 5V
x [2]	Chromoticity Coordinates	White	0.31			
y [2]	Chromaticity Coordinates	vvnite	0.31			
С	Capacitance	White	100		pF	VF=0V;f=1MHz

Notes:

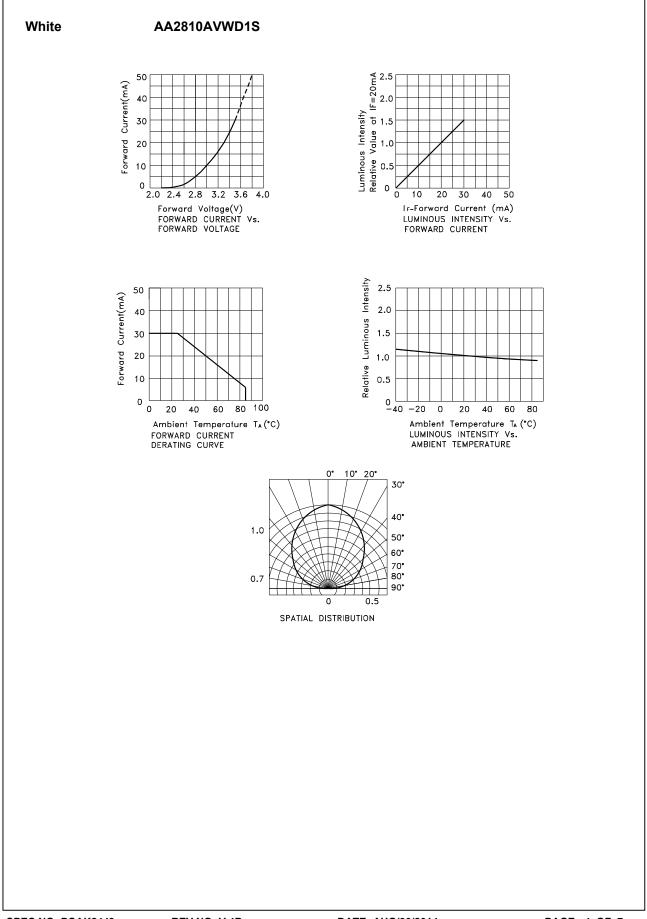
I.Forward Voltage: +/-0.1V.
Measurement Tolerance Of The Chromaticity Coordinates Is ±0.01.
Excess driving current and/or operating temperature higher than recommended conditions may result in severe light degradation or premature failure.

Absolute Maximum Ratings at TA=25°C

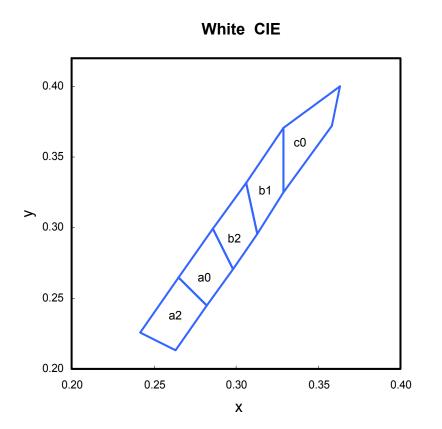
Parameter	White	Units		
Power dissipation	120	mW		
DC Forward Current	30	mA		
Peak Forward Current [1]	100	mA		
Reverse Voltage	5	V		
Operating Temperature	-40°C To +85°C			
Storage Temperature	-40°C To +85°C			

Note:

1. 1/10 Duty Cycle, 0.1ms Pulse Width.



AA2810AVWD1S



	х	У		х	у		х	У
a2	0.263	0.213	a0	0.282	0.245	b2	0.298	0.271
	0.282	0.245		0.298	0.271		0.313	0.296
	0.265	0.265		0.286	0.299		0.306	0.332
	0.242	0.226		0.265	0.265		0.286	0.299
b1	0.313	0.296	c0	0.329	0.325			
	0.329	0.325		0.358	0.372			
	0.329	0.371		0.363	0.400			
	0.306	0.332		0.329	0.371			

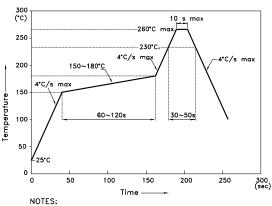
Notes: Shipment may contain more than one chromaticity regions. Orders for single chromaticity region are generally not accepted. Measurement tolerance of the chromaticity coordinates is ± 0.01 .

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AA2810AVWD1S

Reflow soldering is recommended and the soldering profile is shown below. Other soldering methods are not recommended as they might cause damage to the product.

Reflow Soldering Profile For Lead-free SMT Process.



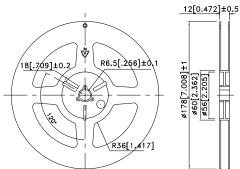
NOTES: 1.We recommend the reflow temperature 245°C(+/-5°C).The maximum soldering temperature should be limited to 260°C. 2.Don't cause stress to the epoxy resin while it is exposed to high temperature. 3.Number of reflow process shall be 2 times or less.



1.4 1.4 0.9 0.2

0.5



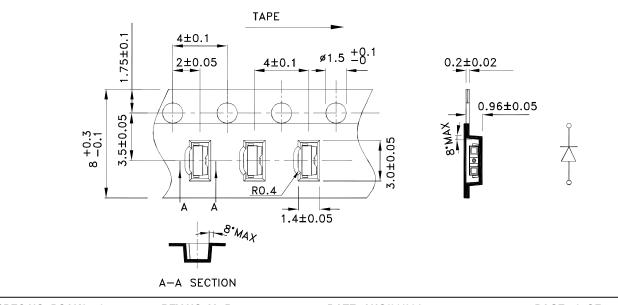


9[0.354]±0.2



0.5

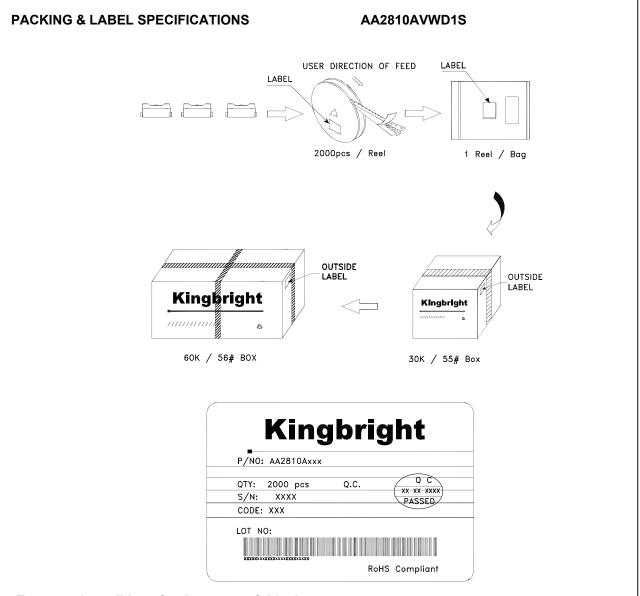
0.9



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